

# S-82M1A Series

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## BATTERY PROTECTION IC FOR 1-CELL PACK

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The S-82M1A Series is a protection IC for lithium-ion / lithium polymer rechargeable batteries, which includes high-accuracy voltage detection circuits and delay circuits. It is suitable for protecting 1-cell lithium-ion / lithium polymer rechargeable battery packs from overcharge, overdischarge, and overcurrent.

By using an external overcurrent detection resistor, the S-82M1A Series realizes high-accuracy overcurrent protection with less effect from temperature change.

#### ■ Features

· High-accuracy voltage detection circuit

Overcharge detection voltage	3.500 V to 4.600 V (5 mV step)	Accuracy ±15 mV
Overcharge release voltage	3.100 V to 4.600 V*1	Accuracy ±50 mV
Overdischarge detection voltage	2.000 V to 3.000 V (10 mV step)	Accuracy ±50 mV
Overdischarge release voltage	2.000 V to 3.400 V*2	Accuracy ±100 mV
Discharge overcurrent detection voltage	0.003 V to 0.100 V (1 mV step)	Accuracy ±3 mV
Load short-circuiting detection voltage	0.010 V to 0.200 V (1 mV step)	Accuracy ±7 mV
Charge overcurrent detection voltage	-0.100 V to -0.003 V (1 mV step)	Accuracy ±3 mV

• Detection delay times are generated only by an internal circuit (external capacitors are unnecessary).

0 V battery charge: Enabled, inhibited
 Power-down function: Available, unavailable

High-withstand voltage:
 VM pin and CO pin: Absolute maximum rating 28 V

• Wide operation temperature range: Ta = -40°C to +85°C

Low current consumption

During operation: 600 nA typ., 990 nA max. (Ta = +25°C)

During power-down: 50 nA max. (Ta = +25°C) During overdischarge: 500 nA max. (Ta = +25°C)

• Lead-free (Sn 100%), halogen-free

- \*1. Overcharge release voltage = Overcharge detection voltage Overcharge hysteresis voltage (Overcharge hysteresis voltage can be selected as 0 V or from a range of 0.1 V to 0.4 V in 50 mV step.)
- \*2. Overdischarge release voltage = Overdischarge detection voltage + Overdischarge hysteresis voltage (Overdischarge hysteresis voltage can be selected as 0 V or from a range of 0.1 V to 0.7 V in 100 mV step.)

#### ■ Applications

- Lithium-ion rechargeable battery pack
- Lithium polymer rechargeable battery pack

#### ■ Package

• SNT-6A

## **■** Block Diagram

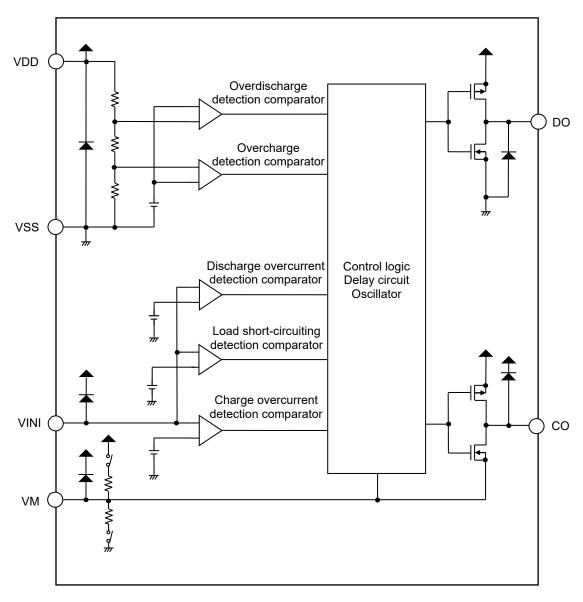
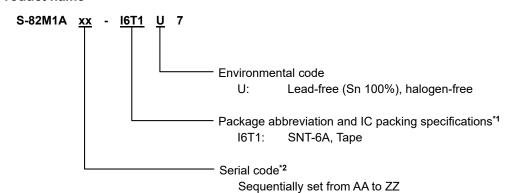


Figure 1

#### **■ Product Name Structure**

#### 1. Product name



- \*1. Refer to the tape drawing.
- \*2. Refer to "3. Product name list".

#### 2. Package

**Table 1 Package Drawing Codes** 

Package Name Dimension		Tape	Reel	Land
SNT-6A	PG006-A-P-SD	PG006-A-C-SD	PG006-A-R-SD	PG006-A-L-SD

#### 3. Product name list

Table 2 (1 / 2)

1000 2 (172)									
Product Name	Overcharge Detection Voltage [Vcu]	Overcharge Release Voltage [VcL]	Over- discharge Detection Voltage	Over- discharge Release Voltage	Discharge Overcurrent Detection Voltage	Load Short-circuiting Detection Voltage	Charge Overcurrent Detection Voltage		
	[vco] [vci]	[]	[V <sub>DL</sub> ]	[V <sub>DU</sub> ]	[V <sub>DIOV</sub> ]	[Vshort]	[Vciov]		
S-82M1AAA-I6T1U7	4.280 V	4.080 V	2.500 V	2.900 V	0.010 V	0.020 V	–0.010 V		
S-82M1AAB-I6T1U7	4.280 V	4.080 V	2.350 V	2.550 V	0.010 V	0.020 V	–0.010 V		
S-82M1AAC-I6T1U7	4.310 V	4.110 V	2.100 V	2.300 V	0.010 V	0.020 V	-0.016 V		
S-82M1AAD-I6T1U7	4.370 V	4.170 V	3.000 V	3.200 V	0.010 V	0.025 V	-0.010 V		
S-82M1AAE-I6T1U7	4.410 V	4.210 V	2.800 V	3.000 V	0.010 V	0.025 V	-0.010 V		

Table 2 (2 / 2)

	iubi	<u> </u>	
Product Name	Delay Time Combination*1	0 V Battery Charge*2	Power-down Function*3
S-82M1AAA-I6T1U7	(1)	Inhibited	Unavailable
S-82M1AAB-I6T1U7	(2)	Inhibited	Available
S-82M1AAC-I6T1U7	(3)	Inhibited	Available
S-82M1AAD-I6T1U7	(1)	Inhibited	Available
S-82M1AAE-I6T1U7	(1)	Inhibited	Available

- \*1. Refer to **Table 3** about the details of the delay time combinations.
- \*2. 0 V battery charge: Enabled, inhibited
- \*3. Power-down function: Available, unavailable

**Remark** Please contact our sales representatives for products other than the above.

#### Table 3

	Overcharge	Overdischarge	Discharge Overcurrent	Load Short-circuiting	Charge Overcurrent
Delay Time	Detection	Detection	Detection	Detection	Detection
Combination Delay Time Delay Time Delay		Delay Time	Delay Time	Delay Time	
	[tcu]	[t <sub>DL</sub> ]	[t <sub>DIOV</sub> ]	[tshort]	[tclov]
(1)	1.0 s	64 ms	8 ms	280 μs	8 ms
(2)	1.0 s	64 ms	32 ms	280 μs	16 ms
(3)	1.0 s	64 ms	32 ms	280 μs	32 ms

**Remark** The delay times can be changed within the range listed below. For details, please contact our sales representatives.

#### Table 4

Delay Time	Symbol		Selection Range				Remark			
Overcharge detection delay time	t <sub>CU</sub>	256 ms	512 ms	1.0 s	-	1	Select a value from the left.			
Overdischarge detection delay time	t <sub>DL</sub>	32 ms	64 ms	128 ms	256 ms	ı	Select a value from the left.			
Discharge overcurrent detection delay time	t <sub>DIOV</sub>	4 ms	8 ms	16 ms	32 ms	64 ms	Select a value from the left.			
Load short-circuiting detection delay time	t <sub>SHORT</sub>	280 μs	530 μs	ı	_	ı	Select a value from the left.			
Charge overcurrent detection delay time	t <sub>CIOV</sub>	4 ms	8 ms	16 ms	32 ms	64 ms	Select a value from the left.			

# ■ Pin Configuration

## 1. SNT-6A

Top view



Figure 2

#### Table 5

Pin No.	Symbol	Description
1	VINI	Overcurrent detection pin
2	со	Connection pin of charge control FET gate (CMOS output)
3	DO	Connection pin of discharge control FET gate (CMOS output)
4	VSS	Input pin for negative power supply
5	VDD	Input pin for positive power supply
6	VM	Input pin for external negative voltage

## ■ Absolute Maximum Ratings

Table 6

(Ta = +25°C unless otherwise specified)

			1	
Item	Symbol	Applied Pin	Absolute Maximum Rating	Unit
Input voltage between VDD pin and VSS pin	V <sub>DS</sub>	VDD	$V_{SS}-0.3$ to $V_{SS}+6$	V
VINI pin input voltage	$V_{VINI}$	VINI	$V_{\text{DD}}-6$ to $V_{\text{DD}}+0.3$	V
VM pin input voltage	$V_{VM}$	VM	$V_{DD}-28$ to $V_{DD}+0.3$	V
DO pin output voltage	$V_{DO}$	DO	$V_{SS}-0.3$ to $V_{DD}+0.3$	V
CO pin output voltage	Vco	СО	$V_{DD}-28$ to $V_{DD}+0.3$	V
Operation ambient temperature	Topr	_	-40 to +85	°C
Storage temperature	T <sub>stg</sub>	_	-55 to +125	°C

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

#### **■** Thermal Resistance Value

Table 7

Item	Symbol	Condition	Min.	Тур.	Max.	Unit	
			Board A	1	224	1	°C/W
			Board B	_	176		°C/W
Junction-to-ambient thermal resistance*1	$\theta_{JA}$	SNT-6A	Board C	_	_	_	°C/W
			Board D	_	_	_	°C/W
			Board E	-	-	ı	°C/W

<sup>\*1.</sup> Test environment: compliance with JEDEC STANDARD JESD51-2A

Remark Refer to "■ Power Dissipation" and "Test Board" for details.

## **■** Electrical Characteristics

#### 1. $Ta = +25^{\circ}C$

Table 8

(Ta = +25°C unless otherwise specified)

				(1a - +23	C unless otherw	lise s	becilied)
ltem	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Detection Voltage							
Overcharge detection voltage	Vcu	-	V <sub>CU</sub> – 0.015	Vcu	V <sub>CU</sub> + 0.015	V	1
-		VcL ≠ Vcu	Vcl - 0.050	VcL	Vcl + 0.050	V	1
Overcharge release voltage	V <sub>CL</sub>	VcL = Vcu	V <sub>CL</sub> - 0.020	VcL	V <sub>CL</sub> + 0.015	V	1
Overdischarge detection voltage	V <sub>DL</sub>	_	V <sub>DL</sub> - 0.050	V <sub>DL</sub>	V <sub>DL</sub> + 0.050	V	2
		$V_{DL} \neq V_{DU}$	V <sub>DU</sub> – 0.100	V <sub>DU</sub>	V <sub>DU</sub> + 0.100	V	2
Overdischarge release voltage	VDU	$V_{DL} = V_{DU}$	V <sub>DU</sub> - 0.050	V <sub>DU</sub>	V <sub>DU</sub> + 0.050	V	2
Discharge overcurrent detection voltage	V <sub>DIOV</sub>	_	V <sub>DIOV</sub> – 0.003	V <sub>DIOV</sub>	V <sub>DIOV</sub> + 0.003	V	2
Load short-circuiting detection voltage	Vshort	-	V <sub>SHORT</sub> - 0.007	Vshort	V <sub>SHORT</sub> + 0.007	V	2
Load short-circuiting detection voltage 2	V <sub>SHORT2</sub>	_	V <sub>DD</sub> – 1.2	V <sub>DD</sub> - 0.8	V <sub>DD</sub> – 0.5	V	2
Charge overcurrent detection voltage	Vciov	_	V <sub>CIOV</sub> - 0.003	Vciov	V <sub>CIOV</sub> + 0.003	V	2
Discharge overcurrent release voltage	V <sub>RIOV</sub>	V <sub>DD</sub> = 3.4 V	$V_{DD} \times 0.77$	$V_{DD} \times 0.80$	$V_{DD} \times 0.83$	V	2
0 V Battery Charge							•
0 V battery charge starting charger	V <sub>0CHA</sub>	0 V battery	0.7	1.1	1.5	V	4
voltage	V 0CHA	charge enabled	0.7	1.1	1.5	V	4
0 V battery charge inhibition battery	Voinh	0 V battery	0.9	1.2	1.5	V	2
voltage	VOINH	charge inhibited	0.9	1.2	1.5	V	
Internal Resistance							
Resistance between VDD pin and VM pin	R <sub>VMD</sub>	$V_{DD} = 1.8 \text{ V},$ $V_{VM} = 0 \text{ V}$	500	1250	2500	kΩ	3
Resistance between VM pin and VSS pin	Rvms	V <sub>DD</sub> = 3.4 V, V <sub>VM</sub> = 1.0 V	5	10	15	kΩ	3
Input Voltage	l .	•	•			ı	1
Operation voltage between VDD pin and VSS pin	V <sub>DSOP1</sub>	-	1.5	-	6.0	٧	_
Operation voltage between VDD pin and VM pin	V <sub>DSOP2</sub>	-	1.5	_	28	٧	-
Input Current							•
Current consumption during operation	Горе	V <sub>DD</sub> = 3.4 V, V <sub>VM</sub> = 0 V	_	600	990	nA	3
Current consumption during power-down	I <sub>PDN</sub>	$V_{DD} = V_{VM} = 1.5 \text{ V}$	_	_	50	nA	3
Current consumption during overdischarge	IOPED	V <sub>DD</sub> = V <sub>VM</sub> = 1.5 V	-	_	500	nA	3
Output Resistance							
CO pin resistance "H"	Rсон	_	5	10	20	kΩ	4
CO pin resistance "L"	Rcol	_	2.5	5	10	kΩ	4
DO pin resistance "H"	Rоон	_	5	10	20	kΩ	4
DO pin resistance "L"	R <sub>DOL</sub>	_	1	2	4	kΩ	4
Delay Time							
Overcharge detection delay time	tcu	_	$t_{\text{CU}} \times 0.7$	tcu	tcu × 1.3	-	5
Overdischarge detection delay time	tol	-	$t_{DL} \times 0.7$	<b>t</b> DL	$t_{DL} \times 1.3$	_	5
Discharge overcurrent detection delay time	tdiov	-	$t_{\text{DIOV}} \times 0.7$	tdiov	$t_{\text{DIOV}} \times 1.3$	-	5
	tshort	-	$t_{\text{SHORT}} \times 0.7$	tshort	t <sub>SHORT</sub> × 1.3	_	5
Charge overcurrent detection delay time	tciov	_	$t_{\text{CIOV}} \times 0.7$	tciov	t <sub>CIOV</sub> × 1.3	_	5
			•				

#### 2. Ta = $-20^{\circ}$ C to $+60^{\circ}$ C<sup>\*1</sup>

Table 9

(Ta = -20°C to +60°C<sup>\*1</sup> unless otherwise specified)

			(1a – –20	C 10 +00 C	' unless otherw	lise st	<i>jecilied</i>
Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Detection Voltage				_		_	
Overcharge detection voltage	Vcu	_	Vcu - 0.020	Vcu	Vcu + 0.020	V	1
O	V	V <sub>CL</sub> ≠ V <sub>CU</sub>	V <sub>CL</sub> - 0.065	VcL	$V_{CL} + 0.057$	V	1
Overcharge release voltage	V <sub>CL</sub>	V <sub>CL</sub> = V <sub>CU</sub>	Vcl - 0.025	V <sub>CL</sub>	Vcl + 0.020	V	1
Overdischarge detection voltage	$V_{DL}$	_	V <sub>DL</sub> - 0.060	$V_{DL}$	V <sub>DL</sub> + 0.055	V	2
-		$V_{DL} \neq V_{DU}$	V <sub>DU</sub> – 0.110	$V_{DU}$	V <sub>DU</sub> + 0.105	V	2
Overdischarge release voltage	V <sub>DU</sub>	$V_{DL} = V_{DU}$	V <sub>DU</sub> – 0.060	V <sub>DU</sub>	V <sub>DU</sub> + 0.055	V	2
Discharge overcurrent detection voltage	$V_{\text{DIOV}}$	_	V <sub>DIOV</sub> - 0.003	V <sub>DIOV</sub>	V <sub>DIOV</sub> + 0.003	V	2
Load short-circuiting detection voltage	Vshort	_	V <sub>SHORT</sub> - 0.007	Vshort	V <sub>SHORT</sub> + 0.007	V	2
Load short-circuiting detection voltage 2	V <sub>SHORT2</sub>	_	V <sub>DD</sub> – 1.4	V <sub>DD</sub> - 0.8	V <sub>DD</sub> – 0.3	V	2
Charge overcurrent detection voltage	Vciov	_	Vciov - 0.003	Vciov	V <sub>CIOV</sub> + 0.003	V	2
Discharge overcurrent release voltage	VRIOV	V <sub>DD</sub> = 3.4 V	$V_{DD} \times 0.77$	$V_{DD} \times 0.80$	$V_{DD} \times 0.83$	V	2
0 V Battery Charge							
0 V battery charge starting charger	V <sub>0</sub> CHA	0 V battery	0.5	1.1	1.7	V	4
voltage		charge enabled					
0 V battery charge inhibition battery	Voinh	0 V battery	0.7	1.2	1.7	V	2
voltage Internal Resistance		charge inhibited					
internal Resistance		V 40V	<u> </u>			1	
Resistance between VDD pin and VM pin	RVMD	V <sub>DD</sub> = 1.8 V, V <sub>VM</sub> = 0 V	250	1250	3500	kΩ	3
Resistance between VM pin and VSS pin	Rvms	V <sub>DD</sub> = 3.4 V, V <sub>VM</sub> = 1.0 V	3.5	10	20	kΩ	3
Input Voltage				•			
Operation voltage between VDD pin and VSS pin	V <sub>DSOP1</sub>	-	1.5	_	6.0	٧	-
Operation voltage between VDD pin and VM pin	V <sub>DSOP2</sub>	-	1.5	-	28	٧	-
Input Current		l	1	l			
Current consumption during operation	Іоре	V <sub>DD</sub> = 3.4 V, V <sub>VM</sub> = 0 V	-	600	1500	nA	3
Current consumption during power-down	IPDN	V <sub>DD</sub> = V <sub>VM</sub> = 1.5 V	_	_	100	nA	3
Current consumption during	_						
overdischarge	IOPED	$V_{DD} = V_{VM} = 1.5 V$	_	_	1000	nA	3
Output Resistance				•			
CO pin resistance "H"	Rcoн	-	2.5	10	30	kΩ	4
CO pin resistance "L"	Rcol	_	1.25	5	15	kΩ	4
DO pin resistance "H"	RDOH	-	2.5	10	30	kΩ	4
DO pin resistance "L"	RDOL	-	0.5	2	6	kΩ	4
Delay Time		•				•	
Overcharge detection delay time	tcu	-	tcu × 0.6	tcu	tcu × 1.4	_	5
Overdischarge detection delay time	t <sub>DL</sub>	_	tol × 0.6	t <sub>DL</sub>	t <sub>DL</sub> × 1.4	_	5
Discharge overcurrent detection delay time	t <sub>DIOV</sub>	-	tdiov × 0.65	t <sub>DIOV</sub>	t <sub>DIOV</sub> × 1.35	_	5
Load short-circuiting detection delay time	tshort	_	tshort × 0.6	tshort	tshort × 1.4		5
Charge overcurrent detection delay time		_	$t_{\text{CIOV}} \times 0.6$		tciov × 1.4		5
Charge Overcurrent detection detay time	tciov	_	1010V X <b>U.U</b>	tciov	IUIUV X 1.4	_	J

<sup>\*1.</sup> Since products are not screened at high and low temperature, the specification for this temperature range is guaranteed by design, not tested in production.

#### 3. Ta = $-40^{\circ}$ C to $+85^{\circ}$ C<sup>\*1</sup>

Table 10

(Ta = -40°C to +85°C<sup>\*1</sup> unless otherwise specified)

			(1a <del>4</del> 0	C 10 +65 C	unless otherw	ise sp	becilied)
ltem	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Detection Voltage							
Overcharge detection voltage	Vcu	_	Vcu - 0.045	Vcu	Vcu + 0.030	V	1
		V <sub>CL</sub> ≠ V <sub>CU</sub>	V <sub>CL</sub> - 0.080	V <sub>CL</sub>	V <sub>CL</sub> + 0.060	V	1
Overcharge release voltage	VcL	V <sub>CL</sub> = V <sub>CU</sub>	Vcl - 0.050	V <sub>CL</sub>	Vcl + 0.030	V	1
Overdischarge detection voltage	V <sub>DL</sub>	_	V <sub>DL</sub> - 0.080	V <sub>DL</sub>	V <sub>DL</sub> + 0.060	V	2
Overdisonarge detection voltage	V DL	V <sub>DL</sub> ≠ V <sub>DU</sub>	V <sub>DU</sub> - 0.130	V <sub>DU</sub>	V <sub>DU</sub> + 0.110	V	2
Overdischarge release voltage	$V_{DU}$					V	
Dil	\ /	$V_{DL} = V_{DU}$	V <sub>DU</sub> - 0.080	V <sub>DU</sub>	V <sub>DU</sub> + 0.060		2
Discharge overcurrent detection voltage	V <sub>DIOV</sub>	_	V <sub>DIOV</sub> – 0.003	V <sub>DIOV</sub>	V <sub>DIOV</sub> + 0.003	V	2
Load short-circuiting detection voltage	VSHORT	_	V <sub>SHORT</sub> – 0.007	Vshort	V <sub>SHORT</sub> + 0.007	V	2
Load short-circuiting detection voltage 2	V <sub>SHORT2</sub>	-	V <sub>DD</sub> – 1.4	$V_{DD} - 0.8$	V <sub>DD</sub> – 0.3	V	2
Charge overcurrent detection voltage	Vciov	-	V <sub>CIOV</sub> – 0.003	Vciov	$V_{CIOV} + 0.003$	V	2
Discharge overcurrent release voltage	$V_{\text{RIOV}}$	$V_{DD} = 3.4 \text{ V}$	$V_{DD} \times 0.77$	$V_{\text{DD}} \times 0.80$	$V_{\text{DD}} \times 0.83$	V	2
0 V Battery Charge							
0 V battery charge starting charger	V <sub>0CHA</sub>	0 V battery	0.5	1.1	1.7	V	4
voltage	V 0CHA	charge enabled	0.5	1.1	1.7	V	4
0 V battery charge inhibition battery		0 V battery	0.7	4.0	4.7	.,	0
voltage	Voinh	charge inhibited	0.7	1.2	1.7	V	2
Internal Resistance		•		•			
	_	V <sub>DD</sub> = 1.8 V,					
Resistance between VDD pin and VM pin	RVMD	V <sub>VM</sub> = 0 V	250	1250	3500	kΩ	3
		V <sub>DD</sub> = 3.4 V,					
Resistance between VM pin and VSS pin	Rvms	V <sub>VM</sub> = 1.0 V	3.5	10	20	kΩ	3
Input Voltage		1.0 0				l	
Operation voltage between VDD pin and							
VSS pin	VDSOP1	_	1.5	-	6.0	V	_
Operation voltage between VDD pin and							
VM pin	VDSOP2	_	1.5	_	28	V	-
Input Current						l	
input current		V <sub>DD</sub> = 3.4 V,				1	
Current consumption during operation	IOPE	$V_{\text{DD}} = 3.4 \text{ V},$ $V_{\text{VM}} = 0 \text{ V}$	_	600	1500	nA	3
Current concumption during newer down	laa.	$V_{DD} = V_{VM} = 1.5 V$	_	_	100	mΛ	2
Current consumption during power-down	IPDN	VDD = VVM = 1.5 V	_	_	100	nA	3
Current consumption during	IOPED	$V_{DD} = V_{VM} = 1.5 V$	_	_	1000	nA	3
overdischarge							
Output Resistance	5	<u> </u>	2.5	40		1.0	
CO pin resistance "H"	Rсон	_	2.5	10	30	kΩ	4
CO pin resistance "L"	Rcol	_	1.25	5	15	kΩ	4
DO pin resistance "H"	RDOH	_	2.5	10	30	kΩ	4
DO pin resistance "L"	RDOL	_	0.5	2	6	kΩ	4
Delay Time		<b>†</b>	<del>1</del>	i -	•		
Overcharge detection delay time	tcu	-	tcu × 0.4	tcu	tcu × 1.6	_	5
Overdischarge detection delay time	$t_{DL}$	_	$t_{DL} \times 0.4$	t <sub>DL</sub>	t <sub>DL</sub> × 1.6	_	5
Discharge overcurrent detection delay							
time	t <sub>DIOV</sub>	_	tDIOV $ imes$ 0.4	tdiov	tdiov × 1.6	_	5
Load short-circuiting detection delay time	tshort	-	tshort $ imes 0.4$	tshort	tshort × 1.6	_	5
Charge overcurrent detection delay time	tciov	_	tciov × 0.4	tciov	tciov × 1.6	_	5
		•					-

<sup>\*1.</sup> Since products are not screened at high and low temperature, the specification for this temperature range is guaranteed by design, not tested in production.

Rev.1.2\_00

#### ■ Test Circuits

Caution Unless otherwise specified, the output voltage levels "H" and "L" at CO pin (V<sub>CO</sub>) and DO pin (V<sub>DO</sub>) are judged by the threshold voltage (1.0 V) of the N-channel FET. Judge the CO pin level with respect to V<sub>VM</sub> and the DO pin level with respect to V<sub>SS</sub>.

#### Overcharge detection voltage, overcharge release voltage (Test circuit 1)

Overcharge detection voltage ( $V_{CU}$ ) is defined as the voltage V1 at which  $V_{CO}$  goes from "H" to "L" when the voltage V1 is gradually increased after setting V1 = 3.4 V. Overcharge release voltage ( $V_{CL}$ ) is defined as the voltage V1 at which  $V_{CO}$  goes from "L" to "H" when the voltage V1 is then gradually decreased. Overcharge hysteresis voltage ( $V_{HC}$ ) is defined as the difference between  $V_{CU}$  and  $V_{CL}$ .

# 2. Overdischarge detection voltage, overdischarge release voltage (Test circuit 2)

Overdischarge detection voltage ( $V_{DL}$ ) is defined as the voltage V1 at which  $V_{DO}$  goes from "H" to "L" when the voltage V1 is gradually decreased after setting V1 = 3.4 V, V2 = V5 = 0 V. Overdischarge release voltage ( $V_{DU}$ ) is defined as the voltage V1 at which  $V_{DO}$  goes from "L" to "H" when setting V2 = 0.03 V, V5 = 0 V and when the voltage V1 is then gradually increased. Overdischarge hysteresis voltage ( $V_{HD}$ ) is defined as the difference between  $V_{DU}$  and  $V_{DL}$ .

# 3. Discharge overcurrent detection voltage, discharge overcurrent release voltage (Test circuit 2)

Discharge overcurrent detection voltage ( $V_{DIOV}$ ) is defined as the voltage V5 whose delay time for changing  $V_{DO}$  from "H" to "L" is discharge overcurrent detection delay time ( $t_{DIOV}$ ) when the voltage V5 is increased after setting V1 = 3.4 V, V2 = 1.4 V, V5 = 0 V. Discharge overcurrent release voltage ( $V_{RIOV}$ ) is defined as the voltage V2 at which  $V_{DO}$  goes from "L" to "H" when setting V2 = 3.4 V, V5 = 0 V and when the voltage V2 is then gradually decreased.

# 4. Load short-circuiting detection voltage (Test circuit 2)

Load short-circuiting detection voltage ( $V_{SHORT}$ ) is defined as the voltage V5 whose delay time for changing  $V_{DO}$  from "H" to "L" is load short-circuiting detection delay time ( $t_{SHORT}$ ) when the voltage V5 is increased after setting V1 = 3.4 V, V2 = 1.4 V, V5 = 0 V.

# 5. Load short-circuiting detection voltage 2 (Test circuit 2)

Load short-circuiting detection voltage 2 ( $V_{SHORT2}$ ) is defined as the voltage V2 whose delay time for changing  $V_{DO}$  from "H" to "L" is  $t_{SHORT}$  when the voltage V2 is increased after setting V1 = 3.4 V, V2 = V5 = 0 V.

# 6. Charge overcurrent detection voltage (Test circuit 2)

Charge overcurrent detection voltage ( $V_{CIOV}$ ) is defined as the voltage V5 whose delay time for changing  $V_{CO}$  from "H" to "L" is charge overcurrent detection delay time ( $t_{CIOV}$ ) when the voltage V5 is decreased after setting V1 = 3.4 V, V2 = V5 = 0 V.

# 7. Current consumption during operation (Test circuit 3)

The current consumption during operation ( $I_{OPE}$ ) is the current that flows through the VDD pin ( $I_{DD}$ ) under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V.

# 8. Current consumption during power-down, current consumption during overdischarge (Test circuit 3)

#### 8. 1 With power-down function

The current consumption during power-down (I<sub>PDN</sub>) is I<sub>DD</sub> under the set conditions of V1 = V2 = 1.5 V, V5 = 0 V.

#### 8. 2 Without power-down function

The current consumption during overdischarge (IOPED) is IDD under the set conditions of V1 = V2 = 1.5 V, V5 = 0 V.

# 9. Resistance between VDD pin and VM pin (Test circuit 3)

R<sub>VMD</sub> is the resistance between VDD pin and VM pin under the set conditions of V1 = 1.8 V, V2 = V5 = 0 V.

#### Resistance between VM pin and VSS pin (Test circuit 3)

 $R_{VMS}$  is the resistance between VM pin and VSS pin when the voltage V5 is decreased to 0 V after setting V1 = 3.4 V, V2 = V5 = 1.0 V.

## 11. CO pin resistance "H"

(Test circuit 4)

The CO pin resistance "H" ( $R_{COH}$ ) is the resistance between VDD pin and CO pin under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V, V3 = 3.0 V.

# 12. CO pin resistance "L" (Test circuit 4)

The CO pin resistance "L" ( $R_{COL}$ ) is the resistance between VM pin and CO pin under the set conditions of V1 = 4.7 V, V2 = V5 = 0 V, V3 = 0.4 V.

#### 13. DO pin resistance "H"

(Test circuit 4)

The DO pin resistance "H" ( $R_{DOH}$ ) is the resistance between VDD pin and DO pin under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V, V4 = 3.0 V.

# 14. DO pin resistance "L" (Test circuit 4)

The DO pin resistance "L" ( $R_{DOL}$ ) is the resistance between VSS pin and DO pin under the set conditions of V1 = 1.8 V, V2 = V5 = 0 V, V4 = 0.4 V.

## 15. Overcharge detection delay time

(Test circuit 5)

After setting V1 = 3.4 V, V2 = V5 = 0 V, the voltage V1 is increased. The time interval from when the voltage V1 exceeds  $V_{CU}$  until  $V_{CO}$  goes to "L" is the overcharge detection delay time ( $t_{CU}$ ).

#### Overdischarge detection delay time (Test circuit 5)

After setting V1 = 3.4 V, V2 = V5 = 0 V, the voltage V1 is decreased. The time interval from when the voltage V1 falls below  $V_{DL}$  until  $V_{DO}$  goes to "L" is the overdischarge detection delay time ( $t_{DL}$ ).

# 17. Discharge overcurrent detection delay time (Test circuit 5)

After setting V1 = 3.4 V, V2 = 1.4 V, V5 = 0 V, the voltage V5 is increased. The time interval from when the voltage V5 exceeds  $V_{DIOV}$  until  $V_{DO}$  goes to "L" is the discharge overcurrent detection delay time ( $t_{DIOV}$ ).

#### Load short-circuiting detection delay time (Test circuit 5)

After setting V1 = 3.4 V, V2 = 1.4 V, V5 = 0 V, the voltage V5 is increased. The time interval from when the voltage V5 exceeds  $V_{SHORT}$  until  $V_{DO}$  goes to "L" is the load short-circuiting detection delay time ( $t_{SHORT}$ ).

#### Charge overcurrent detection delay time (Test circuit 5)

After setting V1 = 3.4 V, V2 = V5 = 0 V, the voltage V5 is decreased. The time interval from when the voltage V5 falls below  $V_{CIOV}$  until  $V_{CO}$  goes to "L" is the charge overcurrent detection delay time ( $t_{CIOV}$ ).

# 20. 0 V battery charge starting charger voltage (0 V battery charge enabled) (Test circuit 4)

The 0 V battery charge starting charger voltage ( $V_{\text{OCHA}}$ ) is defined as the absolute value of voltage V2 at which the current flowing through the CO pin ( $I_{\text{CO}}$ ) exceeds 1.0  $\mu$ A when the voltage V2 is gradually decreased after setting V1 = V5 = 0 V, V2 = V3 = -0.5 V.

# 21. 0 V battery charge inhibition battery voltage (0 V battery charge inhibited) (Test circuit 2)

The 0 V battery charge inhibition battery voltage ( $V_{OINH}$ ) is defined as the voltage V1 at which  $V_{CO}$  goes to "L" ( $V_{CO} = V_{VM}$ ) when the voltage V1 is gradually decreased after setting V1 = 1.9 V, V2 = -2.0 V, V5 = 0 V.

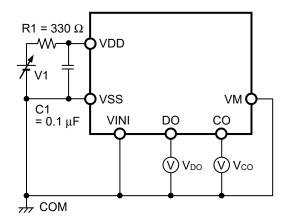


Figure 3 Test Circuit 1

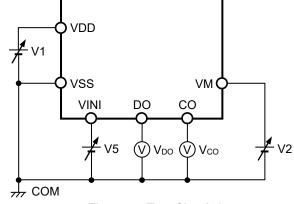


Figure 4 Test Circuit 2

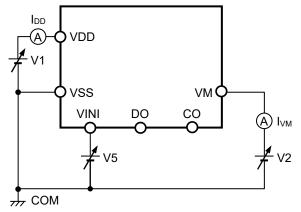


Figure 5 Test Circuit 3

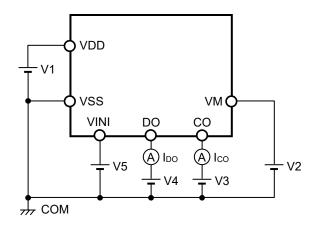


Figure 6 Test Circuit 4

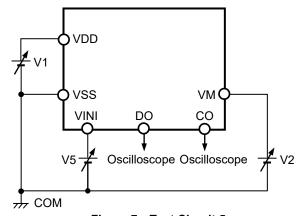


Figure 7 Test Circuit 5

#### Operation

Remark Refer to "■ Battery Protection IC Connection Example".

#### 1. Normal status

The S-82M1A Series monitors the voltage of the battery connected between VDD pin and VSS pin, the voltage between VINI pin and VSS pin to control charging and discharging. When the battery voltage is in the range from overdischarge detection voltage ( $V_{DL}$ ) to overcharge detection voltage ( $V_{CU}$ ), and the VINI pin voltage is in the range from charge overcurrent detection voltage ( $V_{DIOV}$ ) to discharge overcurrent detection voltage ( $V_{DIOV}$ ), the S-82M1A Series turns both the charge and discharge control FETs on. This status is called the normal status, and in this condition charging and discharging can be carried out freely.

The resistance between VDD pin and VM pin ( $R_{VMD}$ ), and the resistance between VM pin and VSS pin ( $R_{VMS}$ ) are not connected in the normal status.

Caution After the battery is connected, discharging may not be carried out. In this case, the S-82M1A Series returns to the normal status by connecting a charger.

#### 2. Overcharge status

#### 2. 1 V<sub>CL</sub> ≠ V<sub>CU</sub> (Product in which overcharge release voltage differs from overcharge detection voltage)

When the battery voltage becomes higher than V<sub>CU</sub> during charging in the normal status and the condition continues for the overcharge detection delay time (t<sub>CU</sub>) or longer, the S-82M1A Series turns the charge control FET off to stop charging. This status is called the overcharge status.

The overcharge status is released in the following two cases.

- (1) In the case that the VM pin voltage is lower than 0.35 V typ., the S-82M1A Series releases the overcharge status when the battery voltage falls below overcharge release voltage (VcL).
- (2) In the case that the VM pin voltage is equal to or higher than 0.35 V typ., the S-82M1A Series releases the overcharge status when the battery voltage falls below  $V_{CU}$ .

When the discharge is started by connecting a load after the overcharge detection, the VM pin voltage rises by the  $V_f$  voltage of the internal parasitic diode than the VSS pin voltage, because the discharge current flows through the parasitic diode in the charge control FET. If this VM pin voltage is equal to or higher than 0.35 V typ., the S-82M1A Series releases the overcharge status when the battery voltage is equal to or lower than  $V_{CU}$ .

Caution

If the battery is charged to a voltage higher than  $V_{\text{CU}}$  and the battery voltage does not fall below  $V_{\text{CU}}$  even when a heavy load is connected, discharge overcurrent detection and load short-circuiting detection do not function until the battery voltage falls below  $V_{\text{CU}}$ . Since an actual battery has an internal impedance of tens of  $m\Omega$ , the battery voltage drops immediately after a heavy load that causes overcurrent is connected, and discharge overcurrent detection and load short-circuiting detection function.

#### 2. 2 V<sub>CL</sub> = V<sub>CU</sub> (Product in which overcharge release voltage is the same as overcharge detection voltage)

When the battery voltage becomes higher than V<sub>CU</sub> during charging in the normal status and the condition continues for t<sub>CU</sub> or longer, the S-82M1A Series turns the charge control FET off to stop charging. This status is called the overcharge status.

In the case that the VM pin voltage is equal to or higher than 0.35 V typ. and the battery voltage falls below  $V_{CU}$ , the S-82M1A Series releases the overcharge status.

When the discharge is started by connecting a load after the overcharge detection, the VM pin voltage rises by the  $V_f$  voltage of the internal parasitic diode than the VSS pin voltage, because the discharge current flows through the parasitic diode in the charge control FET. If this VM pin voltage is equal to or higher than 0.35 V typ., the S-82M1A Series releases the overcharge status when the battery voltage is equal to or lower than  $V_{CU}$ .

- Caution 1. If the battery is charged to a voltage higher than V<sub>CU</sub> and the battery voltage does not fall below V<sub>CU</sub> even when a heavy load is connected, discharge overcurrent detection and load short-circuiting detection do not function until the battery voltage falls below V<sub>CU</sub>. Since an actual battery has an internal impedance of tens of mΩ, the battery voltage drops immediately after a heavy load that causes overcurrent is connected, and discharge overcurrent detection and load short-circuiting detection function.
  - 2. When a charger is connected after overcharge detection, the overcharge status is not released even if the battery voltage is below V<sub>CL</sub>. The overcharge status is released when the discharge current flows and the VM pin voltage goes over 0.35 V typ. by removing the charger.

#### 3. Overdischarge status

When the battery voltage falls below  $V_{DL}$  during discharging in the normal status and the condition continues for the overdischarge detection delay time ( $t_{DL}$ ) or longer, the S-82M1A Series turns the discharge control FET off to stop discharging. This status is called the overdischarge status.

Under the overdischarge status, VDD pin and VM pin are shorted by  $R_{VMD}$  in the S-82M1A Series. The VM pin voltage is pulled up by  $R_{VMD}$ .

When connecting a charger in the overdischarge status, the battery voltage reaches  $V_{DL}$  or higher and the S-82M1A Series releases the overdischarge status if the VM pin voltage is below 0 V typ.

The battery voltage reaches the overdischarge release voltage ( $V_{DU}$ ) or higher and the S-82M1A Series releases the overdischarge status if the VM pin voltage is not below 0 V typ.

R<sub>VMS</sub> is not connected in the overdischarge status.

#### 3. 1 With power-down function

Under the overdischarge status, when the VM pin voltage is 0.7 V typ. or higher, the power-down function works and the current consumption is reduced to the current consumption during power-down (I<sub>PDN</sub>). By connecting a battery charger, the power-down function is released when the VM pin voltage is 0.7 V typ. or lower.

- When a battery is not connected to a charger and the VM pin voltage ≥ 0.7 V typ., the S-82M1A Series maintains the overdischarge status even when the battery voltage reaches V<sub>DU</sub> or higher.
- When a battery is connected to a charger and 0.7 V typ. > the VM pin voltage > 0 V typ., the battery voltage reaches V<sub>DU</sub> or higher and the S-82M1A Series releases the overdischarge status.
- When a battery is connected to a charger and 0 V typ. ≥ the VM pin voltage, the battery voltage reaches V<sub>DL</sub> or higher and the S-82M1A Series releases the overdischarge status.

#### 3. 2 Without power-down function

Under the overdischarge status, the power-down function does not work even when the VM pin voltage is 0.7 V typ. or higher.

- When a battery is not connected to a charger and the VM pin voltage ≥ 0.7 V typ., the battery voltage reaches V<sub>DU</sub>
  or higher and the S-82M1A Series releases the overdischarge status.
- When a battery is connected to a charger and 0.7 V typ. > the VM pin voltage > 0 V typ., the battery voltage reaches V<sub>DU</sub> or higher and the S-82M1A Series releases the overdischarge status.
- When a battery is connected to a charger and 0 V typ. ≥ the VM pin voltage, the battery voltage reaches V<sub>DL</sub> or higher and the S-82M1A Series releases the overdischarge status.

# 4. Discharge overcurrent status (discharge overcurrent, load short-circuiting, load short-circuiting 2)

#### 4. 1 Discharge overcurrent, load short-circuiting

When a battery in the normal status is in the status where the VINI pin voltage is equal to or higher than  $V_{DIOV}$  because the discharge current is equal to or higher than the specified value and the status continues for the discharge overcurrent detection delay time ( $t_{DIOV}$ ) or longer, the discharge control FET is turned off and discharging is stopped. This status is called the discharge overcurrent status.

Under the discharge overcurrent status, VM pin and VSS pin are shorted by R<sub>VMS</sub> in the S-82M1A Series. However, the VM pin voltage is the VDD pin voltage due to the load as long as the load is connected. When the load is disconnected, the VM pin voltage returns to the VSS pin voltage.

When the VM pin voltage returns to  $V_{RIOV}$  or lower, the S-82M1A Series releases the discharge overcurrent status.  $R_{VMD}$  is not connected in the discharge overcurrent status.

#### 4. 2 Load short-circuiting 2

When a battery in the normal status is in the status where a load causing discharge overcurrent is connected, and the VM pin voltage is equal to or higher than the load short-circuiting detection voltage 2 (V<sub>SHORT2</sub>) and the status continues for the load short-circuiting detection delay time (t<sub>SHORT</sub>) or longer, the discharge control FET is turned off and discharging is stopped. This status is called the discharge overcurrent status.

The S-82M1A Series releases the discharge overcurrent status in the same way as in **"4. 1 Discharge overcurrent, load short-circuiting**".

#### 5. Charge overcurrent status

When a battery in the normal status is in the status where the VINI pin voltage is equal to or lower than  $V_{CIOV}$  because the charge current is equal to or higher than the specified value and the status continues for the charge overcurrent detection delay time ( $t_{CIOV}$ ) or longer, the charge control FET is turned off and charging is stopped. This status is called the charge overcurrent status.

The S-82M1A Series releases the charge overcurrent status when the discharge current flows and the VM pin voltage is 0.35 V typ. or higher by removing the charger.

The charge overcurrent detection does not function in the overdischarge status.

#### 6. 0 V battery charge enabled

This function is used to recharge a connected battery whose voltage is 0 V due to self-discharge. When the 0 V battery charge starting charger voltage (V<sub>0CHA</sub>) or a higher voltage is applied between the EB+ and EB- pins by connecting a charger, the charge control FET gate is fixed to the VDD pin voltage.

When the voltage between the gate and source of the charge control FET becomes equal to or higher than the threshold voltage due to the charger voltage, the charge control FET is turned on to start charging. At this time, the discharge control FET is off and the charging current flows through the internal parasitic diode in the discharge control FET. When the battery voltage becomes equal to or higher than  $V_{DL}$ , the S-82M1A Series returns to the normal status.

- Caution 1. Some battery providers do not recommend charging for a completely self-discharged lithium-ion rechargeable battery. It depends on the characteristics of the lithium-ion rechargeable battery to be used; therefore, please ask the battery provider to determine whether to enable or inhibit the 0 V battery charge.
  - 2. The 0 V battery charge has higher priority than the charge overcurrent detection function. Consequently, a product in which use of the 0 V battery charge is enabled charges a battery forcibly and the charge overcurrent cannot be detected when the battery voltage is lower than V<sub>DL</sub>.

#### 7. 0 V battery charge inhibited

This function inhibits charging when a battery that is internally short-circuited (0 V battery) is connected. When the battery voltage is the 0 V battery charge inhibition battery voltage ( $V_{OINH}$ ) or lower, the charge control FET gate is fixed to the EB– pin voltage to inhibit charging. When the battery voltage is  $V_{OINH}$  or higher, charging can be performed.

Caution Some battery providers do not recommend charging for a completely self-discharged lithium-ion rechargeable battery. It depends on the characteristics of the lithium-ion rechargeable battery to be used; therefore, please ask the battery provider to determine whether to enable or inhibit the 0 V battery charge.

#### 8. Delay circuit

The detection delay times are determined by dividing a clock of approximately 4 kHz by the counter.

**Remark**  $t_{DIOV}$  and  $t_{SHORT}$  start when  $V_{DIOV}$  is detected. When  $V_{SHORT}$  is detected over  $t_{SHORT}$  after the detection of  $V_{DIOV}$ , the S-82M1A Series turns the discharge control FET off within  $t_{SHORT}$  of each detection.

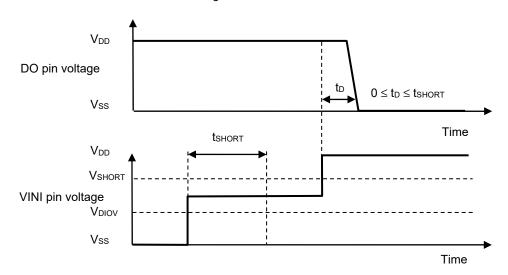
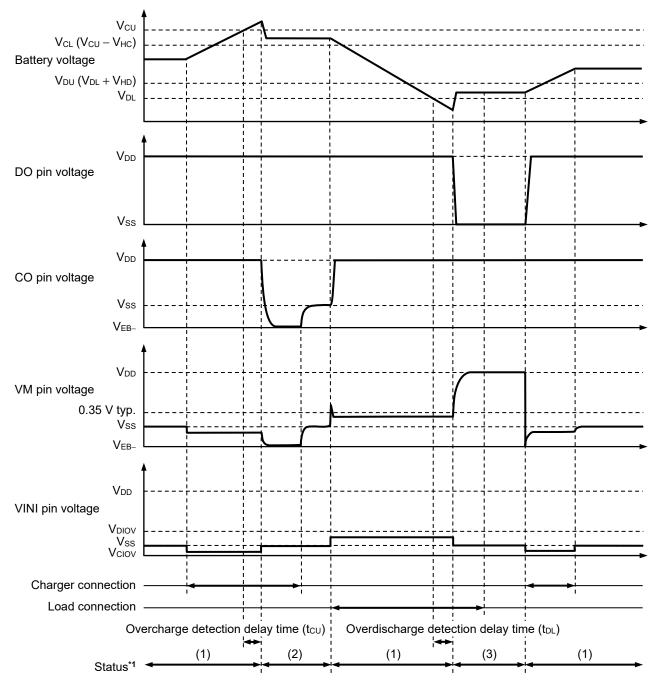


Figure 8

## **■** Timing Charts

#### 1. Overcharge detection, overdischarge detection



\*1. (1): Normal status

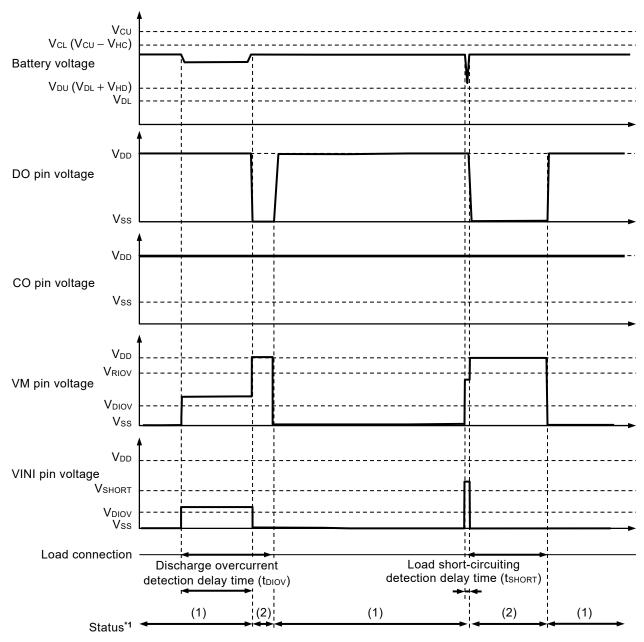
(2): Overcharge status

(3): Overdischarge status

**Remark** The charger is assumed to charge with a constant current.

Figure 9

#### 2. Discharge overcurrent detection

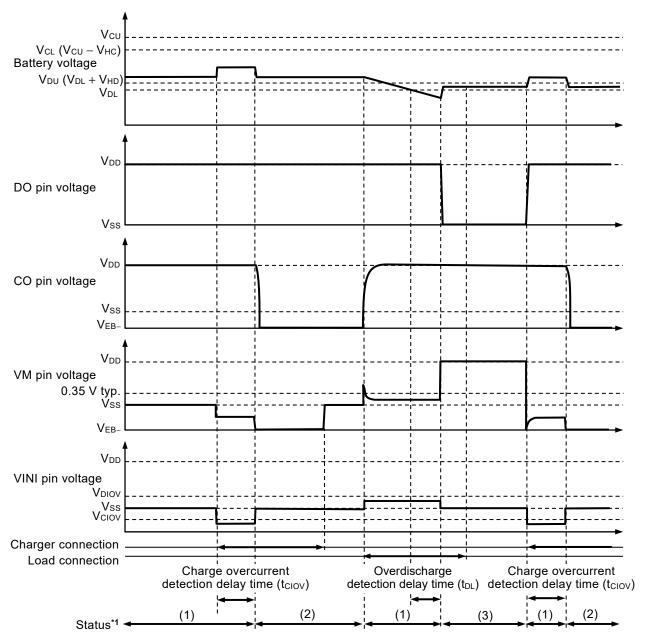


\*1. (1): Normal status

(2): Discharge overcurrent status

Figure 10

#### 3. Charge overcurrent detection



- \*1. (1): Normal status
  - (2): Charge overcurrent status
  - (3): Overdischarge status

**Remark** The charger is assumed to charge with a constant current.

Figure 11

## ■ Battery Protection IC Connection Example

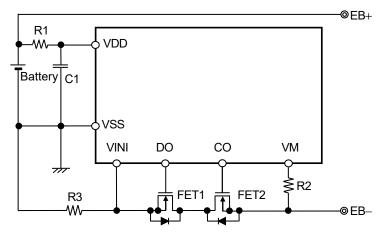


Figure 12

**Table 11 Constants for External Components** 

Symbol	Part	Purpose	Min.	Тур.	Max.	Remark
FET1	Nch MOS FET	Discharge control	_	_	_	Threshold voltage ≤ Overdischarge detection voltage*1
FET2	Nch MOS FET	Charge control	_	_	_	Threshold voltage ≤ Overdischarge detection voltage*1
R1	Resistor	ESD protection, For power fluctuation	270 Ω	330 Ω	1.0 kΩ*²	-
C1	Capacitor	For power fluctuation	0.1 μF	0.1 μF	1.0 μF	_
R2	Resistor	ESD protection, Protection for reverse connection of a charger	300 Ω	470 Ω	750 Ω	_
R3	Resistor	Overcurrent detection	_	$3.0~\text{m}\Omega$	_	-

<sup>\*1.</sup> If a FET with a threshold voltage equal to or higher than the overdischarge detection voltage is used, discharging may be stopped before overdischarge is detected.

#### Caution 1. The constants may be changed without notice.

2. It has not been confirmed whether the operation is normal or not in circuits other than the connection example. In addition, the connection example and the constants do not guarantee proper operation. Perform thorough evaluation using the actual application to set the constants.

<sup>\*2.</sup> Accuracy of overcharge detection voltage is guaranteed by R1 = 330  $\Omega$ . Connecting resistors with other values will worsen the accuracy.

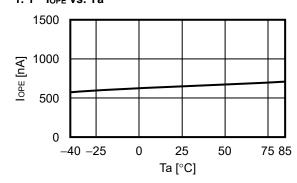
#### ■ Precautions

- The application conditions for the input voltage, output voltage, and load current should not exceed the power dissipation.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- ABLIC Inc. claims no responsibility for any and all disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

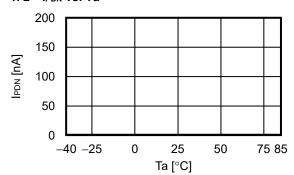
# ■ Characteristics (Typical Data)

#### 1. Current consumption

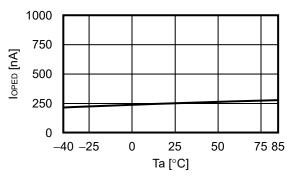
# 1. 1 IOPE vs. Ta



1. 2 IPDN vs. Ta

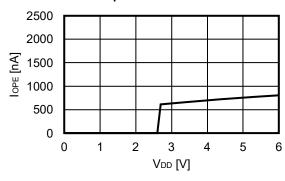


1. 3 loped vs. Ta

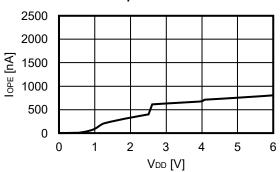


#### 1. 4 IOPE VS. VDD

1. 4. 1 With power-down function

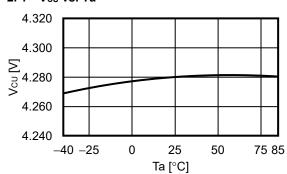


1. 4. 2 Without power-down function

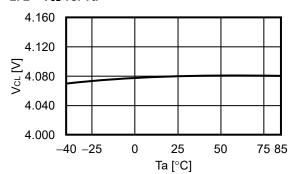


#### 2. Detection voltage

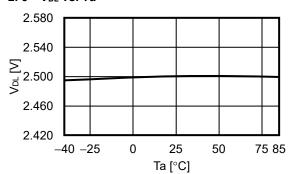
#### 2. 1 V<sub>CU</sub> vs. Ta



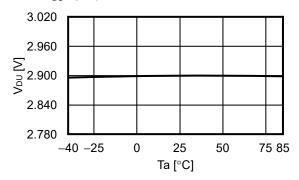
#### 2. 2 V<sub>CL</sub> vs. Ta



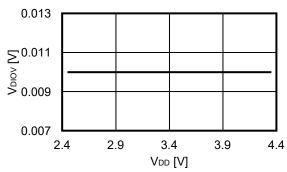
2. 3 V<sub>DL</sub> vs. Ta



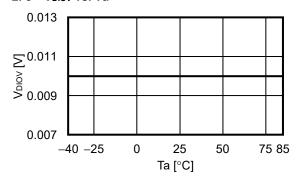
2. 4 V<sub>DU</sub> vs. Ta



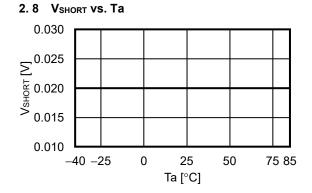
#### $2.\ 5\quad V_{\text{DIOV}}\ vs.\ V_{\text{DD}}$

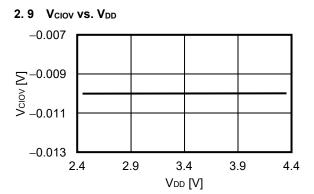


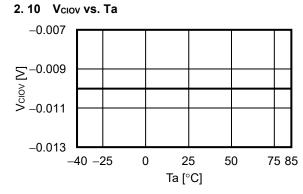
2. 6 V<sub>DIOV</sub> vs. Ta



# 2. 7 VSHORT VS. VDD 0.030 0.025 0.025 0.015 0.010 2.4 2.9 3.4 3.9 4.4 VDD [V]

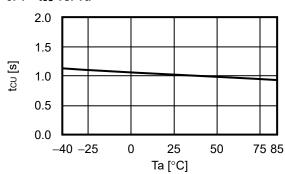




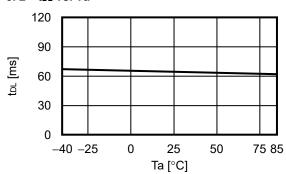


#### 3. Delay time

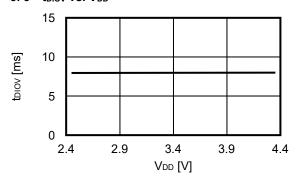
#### 3. 1 tcu vs. Ta



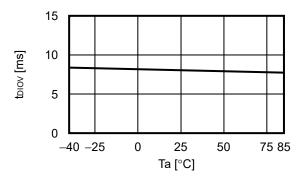
3. 2 t<sub>DL</sub> vs. Ta



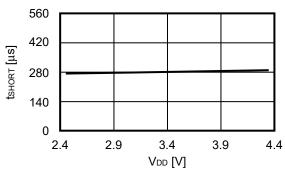
3. 3 tolov vs. VDD



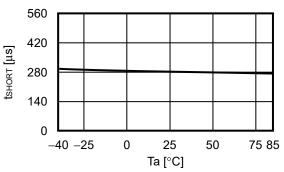
3. 4 t<sub>DIOV</sub> vs. Ta



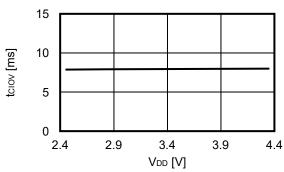
3. 5 tshort vs. VDD



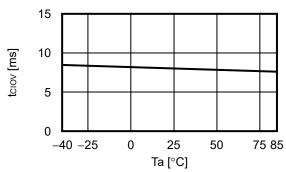
3. 6 tshort vs. Ta



3. 7 tciov vs. VDD

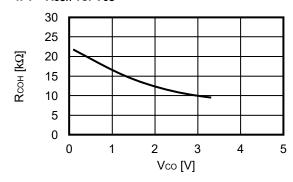


3.8 tciov vs. Ta

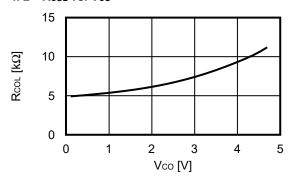


#### 4. Output resistance

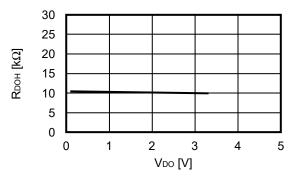
## 4. 1 Rcon vs. Vco



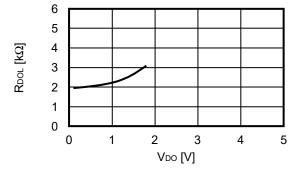
## 4. 2 Rcol vs. Vco



## 4. 3 RDOH VS. VDO



#### 4. 4 RDOL VS. VDO

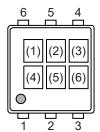


Rev.1.2\_00

# ■ Marking Specifications

#### 1. SNT-6A

Top view



(1) to (3): Product code (Refer to **Product name vs. Product code**)

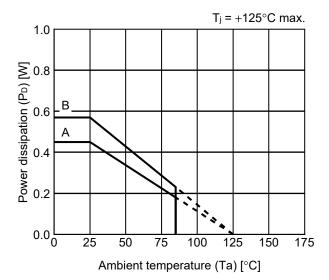
(4) to (6): Lot number

#### Product name vs. Product code

Due do et Nome	Product Code			
Product Name	(1)	(2)	(3)	
S-82M1AAA-I6T1U7	8	L	S	
S-82M1AAB-I6T1U7	8	L	Т	
S-82M1AAC-I6T1U7	8	L	U	
S-82M1AAD-I6T1U7	8	Ĺ	V	
S-82M1AAE-I6T1U7	8	L	W	

# **■** Power Dissipation

## SNT-6A

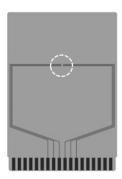


Board	Power Dissipation (P <sub>D</sub> )	
Α	0.45 W	
В	0.57 W	
С	_	
D	_	
Е	_	

# **SNT-6A** Test Board

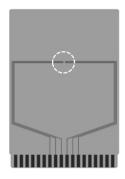
## (1) Board A





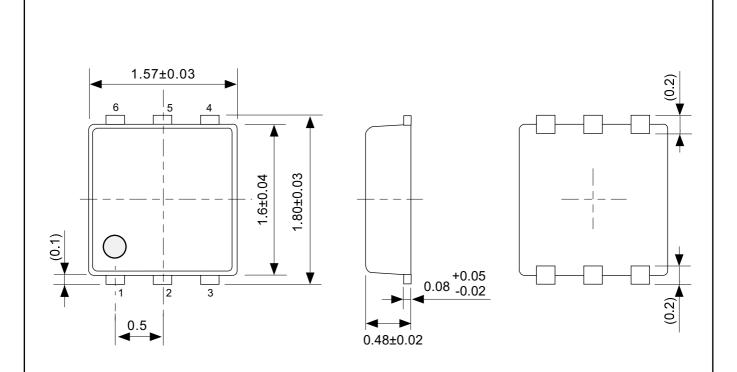
Item		Specification	
Size [mm]		114.3 x 76.2 x t1.6	
Material		FR-4	
Number of copper foil la	ayer	2	
	1	Land pattern and wiring for testing: t0.070	
Coppor foil layer [mm]	2	-	
Copper foil layer [mm]	3	-	
	4	74.2 x 74.2 x t0.070	
Thermal via		-	

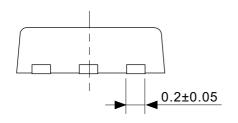
# (2) Board B



Item		Specification	
Size [mm]		114.3 x 76.2 x t1.6	
Material		FR-4	
Number of copper foil layer		4	
	1	Land pattern and wiring for testing: t0.070	
Copper foil layer [mm]	2	74.2 x 74.2 x t0.035	
Copper foil layer [ITIII]	3	74.2 x 74.2 x t0.035	
	4	74.2 x 74.2 x t0.070	
Thermal via		-	

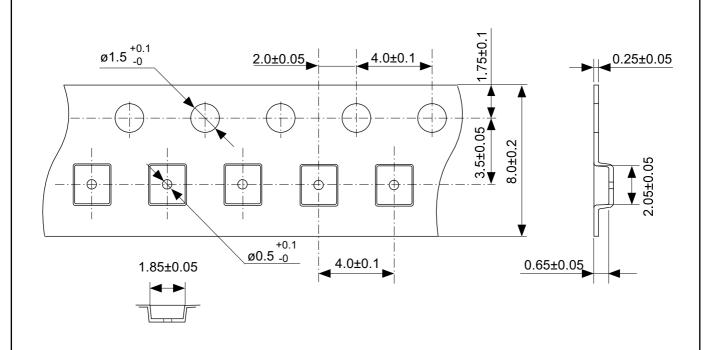
No. SNT6A-A-Board-SD-1.0

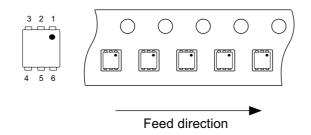




# No. PG006-A-P-SD-2.1

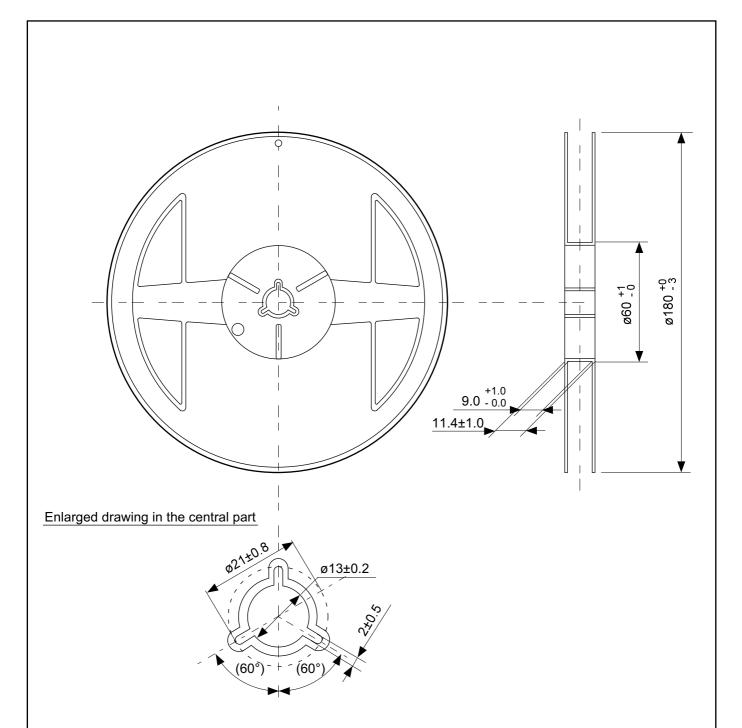
TITLE	SNT-6A-A-PKG Dimensions		
No.	PG006-A-P-SD-2.1		
ANGLE	<b>\$</b>		
UNIT	mm		
ABLIC Inc.			





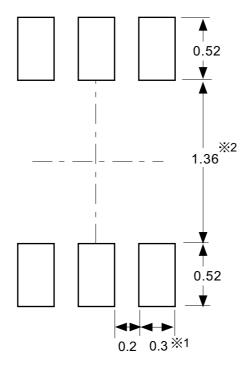
# No. PG006-A-C-SD-2.0

TITLE	SNT-6A-A-Carrier Tape				
No.	PG006-A-C-SD-2.0				
ANGLE					
UNIT	mm				
ABLIC Inc.					



# No. PG006-A-R-SD-2.0

TITLE	SNT-6A-A-Reel		
No.	PG006-A-R-SD-2.0		
ANGLE		QTY.	5,000
UNIT	mm		
ABLIC Inc.			



%1. ランドパターンの幅に注意してください (0.25 mm min. / 0.30 mm typ.)。 %2. パッケージ中央にランドパターンを広げないでください (1.30 mm ~ 1.40 mm)。

- 注意 1. パッケージのモールド樹脂下にシルク印刷やハンダ印刷などしないでください。
  - 2. パッケージ下の配線上のソルダーレジストなどの厚みをランドパターン表面から0.03 mm 以下にしてください。
  - 3. マスク開口サイズと開口位置はランドパターンと合わせてください。
  - 4. 詳細は "SNTパッケージ活用の手引き" を参照してください。
- ※1. Pay attention to the land pattern width (0.25 mm min. / 0.30 mm typ.).
- ※2. Do not widen the land pattern to the center of the package (1.30 mm ~ 1.40 mm).
- Caution 1. Do not do silkscreen printing and solder printing under the mold resin of the package.
  - 2. The thickness of the solder resist on the wire pattern under the package should be 0.03 mm or less from the land pattern surface.
  - 3. Match the mask aperture size and aperture position with the land pattern.
  - 4. Refer to "SNT Package User's Guide" for details.
- ※1. 请注意焊盘模式的宽度 (0.25 mm min. / 0.30 mm typ.)。
- ※2. 请勿向封装中间扩展焊盘模式 (1.30 mm~1.40 mm)。
- 注意 1. 请勿在树脂型封装的下面印刷丝网、焊锡。
  - 2. 在封装下、布线上的阻焊膜厚度 (从焊盘模式表面起) 请控制在 0.03 mm 以下。
  - 3. 钢网的开口尺寸和开口位置请与焊盘模式对齐。
  - 4. 详细内容请参阅 "SNT 封装的应用指南"。

No. PG006-A-L-SD-4.1

TITLE	SNT-6A-A -Land Recommendation		
No.	PG006-A-L-SD-4.1		
ANGLE			
UNIT	mm		
ABLIC Inc.			

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